MA3D752 (MA7D52), MA3D752A (MA7D52A)

Silicon epitaxial planar type (cathode common)

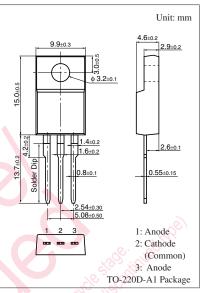
For switching mode power supply

Features

- Low forward voltage V_F
- High dielectric breakdown voltage: > 5 kV
- Easy-to-mount, due to its V cut lead end

Absolute Maximum Hatings $T_a = 23$ C							
Parameter		Symbol	Rating	Unit			
Repetitive peak	MA3D752	V _{RRM}	40	V			
reverse voltage	MA3D752A		45				
Non-repetitive peak	MA3D752	V _{RSM}	40	V			
forward surge voltage							
Forward current (Average)		I _{F(AV)}	20	A			
Non-repetitive peak forward		I _{FSM}	120	A			
surge current *							
Junction temperature		Tj	-40 to +125	°C			
Storage temperature		T _{stg}	-40 to +125	°C			





Note) *: Half sine wave; 10 ms/cycle

Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Paramet	er	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage		$V_{\rm F}$	$I_{\rm F} = 10 \text{ A}, T_{\rm C} = 25^{\circ}{\rm C}$			0.55	V
Reverse current	MA3D752	I _R	$V_{\rm R} = 40 \text{ V}, \text{ T}_{\rm C} = 25^{\circ} \text{C}$			5	mA
	MA3D752A		$V_{R} = 45 \text{ V}, T_{C} = 25^{\circ}\text{C}$			5	
Thermal resistance (j-c)		R _{th(j-c)}				3.0	°C/W

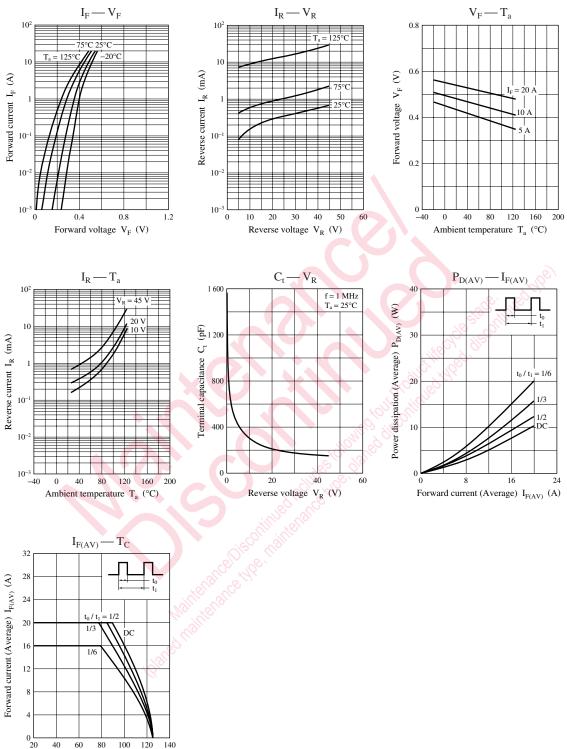
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.

3. Absolute frequency of input and output is 100 MHz.

Note) The part numbers in the parenthesis show conventional part number.

Panasonic



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